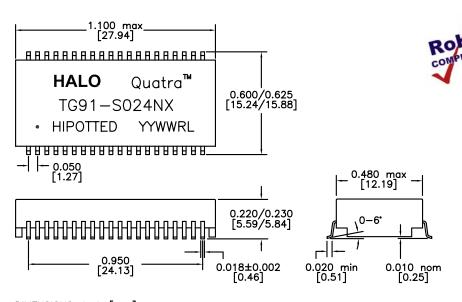
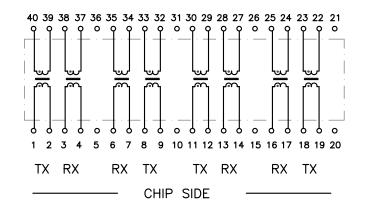
US PATENT NO. 5,656,985 6,297,720B1 6,297,721B1 6,320,489B1 6,344,785B1 PRELIMINARY



DIMENSIONS: Inch [mm]
CO-PLANARITY: 0.004 [0.10]

TOLERANCES: ±0.005 INCH IF NOT SPECIFIED



PART NO.: TG91-S024NXRL

FOUR PORT T1/E1 ISOLATION TRANSFORMER MODULE COMPATIBLE TO USE WITH TELELINK (TECCOR) DEVICES RoHS COMPLIANT

COMPATIBLE TO LEAD-FREE SOLDERING PROCESS CONDITION PER IPC/JEDEC J-STD-020C

UL/EN60950 AND DEMKO RECOGNIZED OPERATING TEMPERATURE -40/+85°C

ELECTRICAL SPECIFICATIONS @25° C

TURNS RATIO

TX P1-2:P40-39,P8-9:P33-32, 1:2.4 $\pm 2\%$

P11-12:P30-29,P18-19:P23-22

RX P3-4:38-37,P6-7:P35-34, 1:1 $\pm 2\%$

P13-14:P28-27,P16-17:P25-24

OCL (CHIP SIDE) 1.5mH typ

DCR (CHIP SIDE) 0.8Ω max

LL (CHIP SIDE) 0.5 µH max

Cw/w 35pF max

ISOLATION 1,500Vrms



HALO/PBL

CALIFORNIA, USA KOWLOON, HONG KONG SINGAPORE

| | TITLE | ISOLATION | OLATION TRANSFORMERS | | | SIGNATURES | | REV. | DESC. | DATE |
|---------|----------|---------------|----------------------|-------------------|----------|------------------|--------|------|-------------|--------|
| H | FOR | T1 /E1 | | · · · · · · · · · | DRAWN | PETER LU | 2/5/07 | Α | FIRST ISSUE | 2/5/07 |
| \perp | | 11/61 | | | CHECKED | LEI KEONG | 2/5/07 | | | |
| ┪ | PART NO. | TG91-S024NXRL | | | APPROVED | PETER LU | 2/5/07 | | | |
| | SCALE | NONE | PAGE | 1 of 1 | FILE | TG91S024NXRL.DWG | | | | |

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